

NEC's 6-PIN DIP 400 V BREAK DOWN VOLTAGE 1-CH OPTICAL COUPLED MOS FET

PS7142-1A PS7142L-1A

FEATURES

1 CHANNEL TYPE:

1 a Output

LOW LED OPERATING CURRENT:

IF= 2mA

· DESIGNED FOR AC/DC SWITCHING LINE CHANGER

SMALL PACKAGE:
 6-Pin DIP

LOW OFFSET VOLTAGE

 PS7142L-1A: Surface mount type

· SAFETY STANDARDS:

UL approved: File No. E72422 (S) BSI approved: File No. 8245/8246 CSA approved: File No. CA 101391

DESCRIPTION

NEC's PS7142-1A and PS7142L-1A are solid state relays containing GaAs LEDs on the light emitting side (input side) and MOS FETs on the output side.

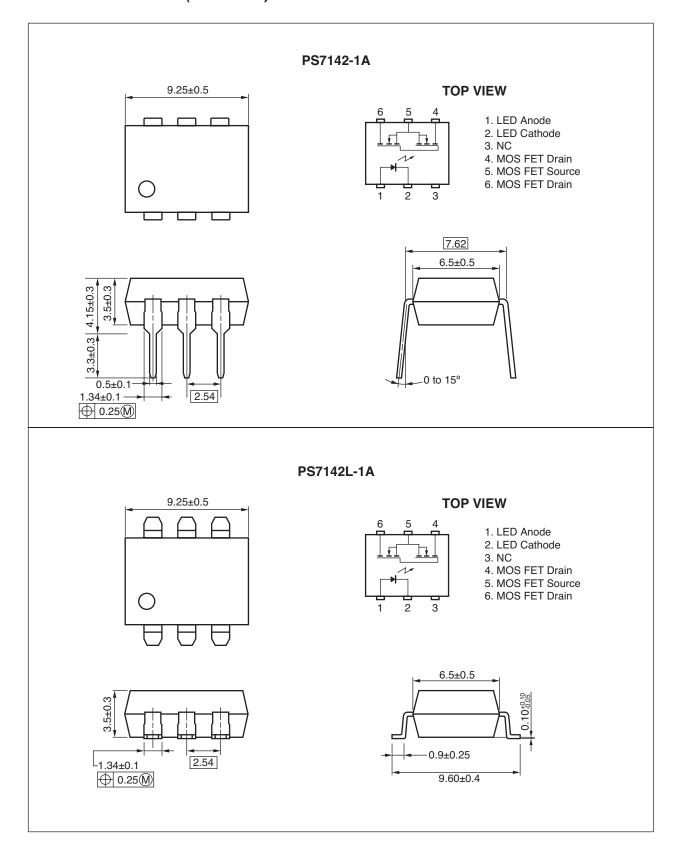
They are suitable for analog signal control because of their low offset and high linearity.

The PS7142L-1A has a surface mount type lead.

APPLICATION

- · Exchange Equipment
- · Measurement Equipment
- · FA/OA Equipment

PACKAGE DIMENSIONS (UNIT: mm)



ORDERING INFORMATION (Pb-Free)

PART NUMBER	PACKAGE	PACKING STYLE	APPLICATION PART NUMBER *1
PS7142-1A-A	6-pin DIP	Magazine case 50 pcs	PS7142-1A
PS7142L-1A-A			PS7142L-1A
PS7142L-1A-E3-A		Embossed Tape 1000 pcs/reel	
PS7142L-1A-E4-A			

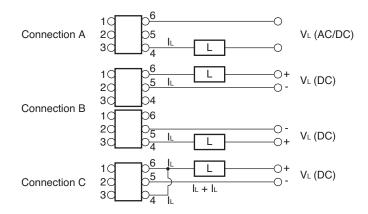
^{*1} For the application of the Safety Standard, following part number should be used.

ABSOLUTE MAXIMUM RATINGS (TA = 25°C, unless otherwise Specified)

PARAMETER			SYMBOL	RATINGS	UNIT
Diode	Forward Current (DC)		lF	50	mA
	Reverse Voltage		VR	5.0	V
	Power Dissipation		Po	50	mW
	Peak Forward Current ^{*1}		IFP	1	А
MOS FET	MOS FET Break Down Voltage		VL	400	V
	Continuous	Connection A	IL	200	mA
	Load Current*2	Connection B		250	1
		Connection C		400	j
	Pulse Load Current *3 (AC/DC Connection)		ILP	400	mA
Power Dissipation			PD	560	mW
Isolation Voltage *4			BV	1 500	Vr.m.s.
Total Power Dissipation			Рт	610	mW
Operating Ambient Temperature			TA	-40 to +85	°C
Storage Temperature			T _{stg}	-40 to +100	°C

^{*1} PW = 100 μ s, Duty Cycle = 1 %

^{*2} Conditions: IF \geq 2 mA. The following types of load connections are available.



^{*3} PW = 100 ms, 1 shot

^{*4} AC voltage for 1 minute at $T_A = 25$ °C, RH = 60 % between input and output

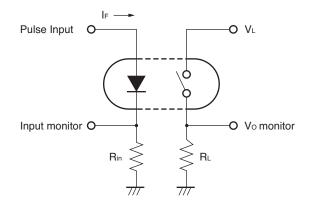
RECOMMENDED OPERATING CONDITIONS (TA = 25°C)

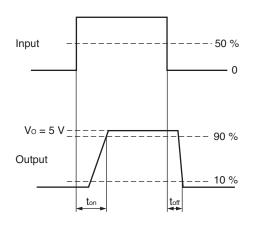
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT
LED Operating Current	lF	2	10	20	mA
LED Off Voltage	VF	0		0.5	V

ELECTRICAL CHARACTERISTICS (TA = 25°C)

PARAMETER		SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Diode	Forward Voltage	VF	I _F = 10 mA		1.2	1.4	V
	Reverse Current	l _R	V _R = 5 V			5.0	μΑ
MOS FET	Off-state Leakage Current	Loff	V _D = 400 V		0.03	1.0	μΑ
	Output Capacitance	Cout	V _D = 0 V, f = 1 MHz		225		pF
Coupled	LED On-state Current	Fon	IL = 200 mA			2.0	mA
	On-state Resistance	Ron1	IF = 10 mA, IL = 10 mA		6.0	10	Ω
		Ron2	I _F = 10 mA, I _L = 200 mA, t ≤ 10 ms				
	Turn-on Time*1	ton	I _F = 10 mA, V _O = 5 V, R _L = 500 Ω,		0.8	5.0	ms
	Turn-off Time*1	toff	PW ≥ 10 ms		0.02	0.2	
	Isolation Resistance	Ri-o	Vi-o = 1.0 kVpc	10º			Ω
	Isolation Capacitance	C _{I-O}	V = 0 V, f = 1 MHz		1.1		pF

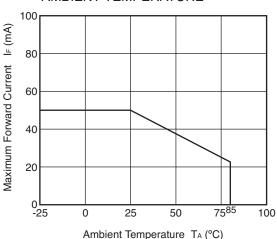
^{*1} Test Circuit for Switching Time



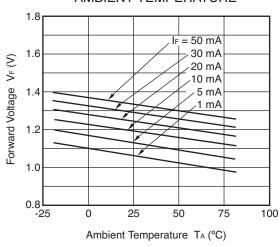


TYPICAL CHARACTERISTICS (TA = 25°C, unless otherwise specified)

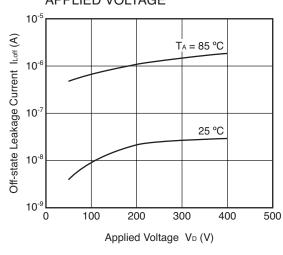




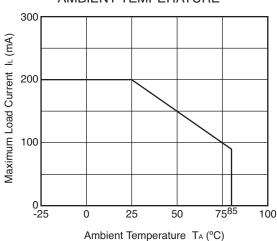
FORWARD VOLTAGE vs. AMBIENT TEMPERATURE



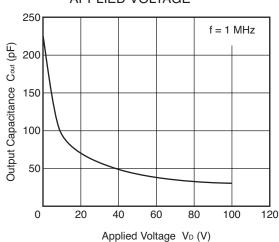
OFF-STATE LEAKAGE CURRENT vs. APPLIED VOLTAGE



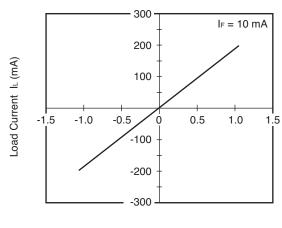
MAXIMUM LORD CURRENT vs. AMBIENT TEMPERATURE



OUTPUT CAPACITANCE vs. APPLIED VOLTAGE

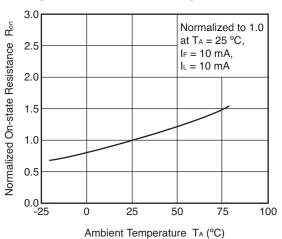


LORD CURRENT vs. LORD VOLTAGE

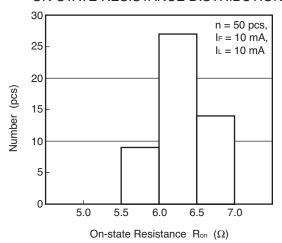


Load Voltage V_L (V)

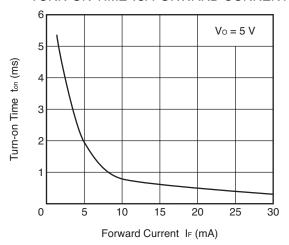
NORMALIZED ON-STATE RESISTANCE vs. AMBIENT TEMPERATURE



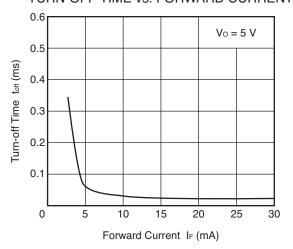
ON-STATE RESISTANCE DISTRIBUTION



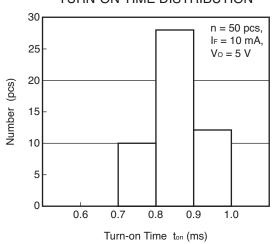
TURN-ON TIME vs. FORWARD CURRENT



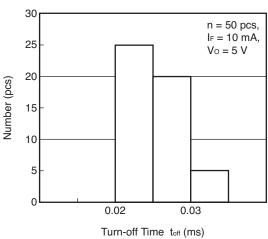
TURN-OFF TIME vs. FORWARD CURRENT



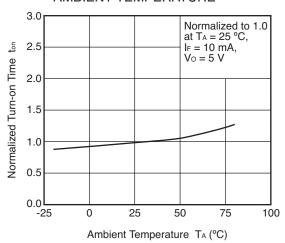
TURN-ON TIME DISTRIBUTION



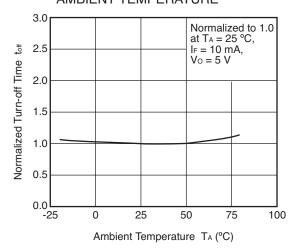
TURN-OFF TIME DISTRIBUTION



NORMALIZED TURN-ON TIME vs. AMBIENT TEMPERATURE

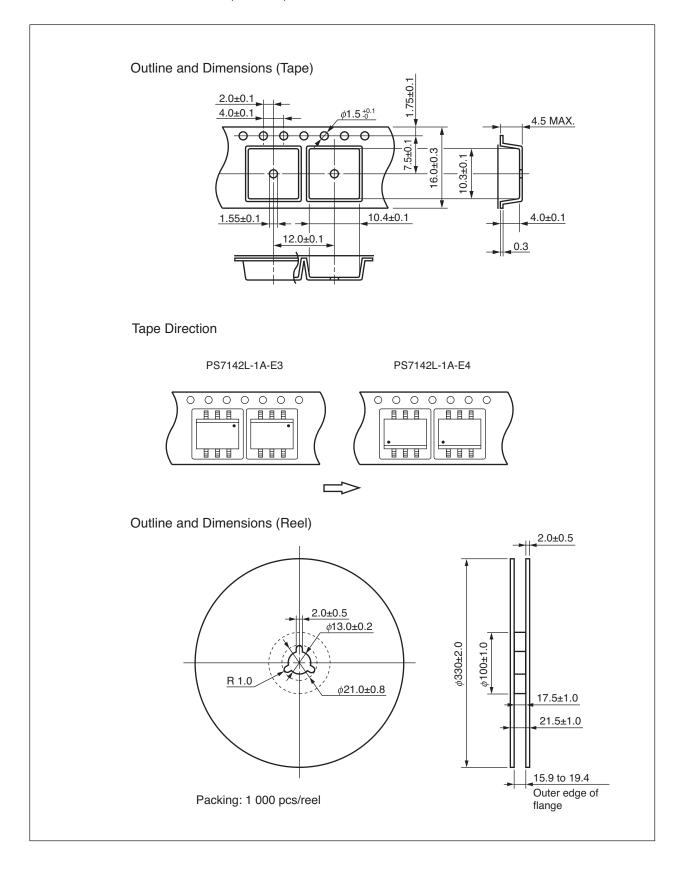


NORMALIZED TURN-OFF TIME vs. AMBIENT TEMPERATURE



Remark The graphs indicate nominal characteristics.

TAPING SPECIFICATIONS (UNIT:mm)



RECOMMENDED SOLDERING CONDITIONS

(1) Infrared reflow soldering

· Peak reflow temperature 260°C or below (package surface temperature)

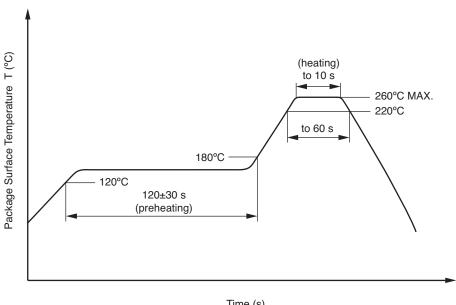
· Time of peak reflow temperature 10 seconds or less · Time of temperature higher than 220°C 60 seconds or less

• Time to preheat temperature from 120 to 180°C 120±30 s · Number of reflows Three

• Flux Rosin flux containing small amount of chlorine (The flux with a maximum

chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



Time (s)

(2) Wave soldering

 Temperature 260°C or below (molten solder temperature)

• Time 10 seconds or less

· Preheating conditions 120°C or below (package surface temperature)

· Number of times One

• Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2

Wt% is recommended.)

(3) Cautions

Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

Life Support Applications

These NEC products are not intended for use in life support devices, appliances, or systems where the malfunction of these products can reasonably be expected to result in personal injury. The customers of CEL using or selling these products for use in such applications do so at their own risk and agree to fully indemnify CEL for all damages resulting from such improper use or sale.



Subject: Compliance with EU Directives

CEL certifies, to its knowledge, that semiconductor and laser products detailed below are compliant with the requirements of European Union (EU) Directive 2002/95/EC Restriction on Use of Hazardous Substances in electrical and electronic equipment (RoHS) and the requirements of EU Directive 2003/11/EC Restriction on Penta and Octa BDE.

CEL Pb-free products have the same base part number with a suffix added. The suffix –A indicates that the device is Pb-free. The –AZ suffix is used to designate devices containing Pb which are exempted from the requirement of RoHS directive (*). In all cases the devices have Pb-free terminals. All devices with these suffixes meet the requirements of the RoHS directive.

This status is based on CEL's understanding of the EU Directives and knowledge of the materials that go into its products as of the date of disclosure of this information.

Restricted Substance per RoHS	Concentration Limit per RoHS (values are not yet fixed)	Concentration contained in CEL devices		
Lead (Pb)	< 1000 PPM	-A Not Detected	-AZ (*)	
Mercury	< 1000 PPM	Not Detected		
Cadmium	< 100 PPM	Not Detected		
Hexavalent Chromium	< 1000 PPM	Not Detected		
PBB	< 1000 PPM	Not Detected		
PBDE	< 1000 PPM	Not Detected		

If you should have any additional questions regarding our devices and compliance to environmental standards, please do not hesitate to contact your local representative.

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In no event shall CEL's liability arising out of such information exceed the total purchase price of the CEL part(s) at issue sold by CEL to customer on an annual basis.

See CEL Terms and Conditions for additional clarification of warranties and liability.